

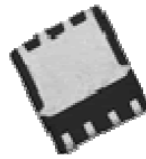
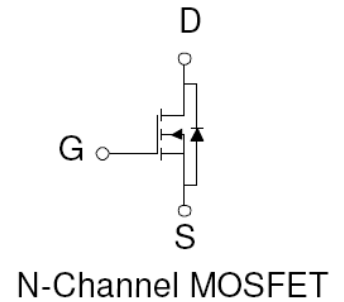
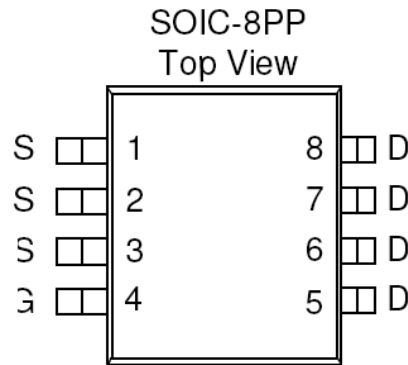
MSS34N40 N-Channel 40-V (D-S) MOSFET

FEATURES

- Low RDS (on) trench technology
- Low thermal impedance
- Fast switching speed

Typical Applications:

- PoE Power Sourcing Equipment
- PoE Powered Devices
- Telecom DC/DC converters
- White LED boost converters



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ UNLESS OTHERWISE NOTED)				
Parameter		Symbol	Limit	Units
Drain-Source Voltage		V_{DS}	40	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ^a	$T_A=25\text{ }^\circ\text{C}$	I_D	± 34	A
	$T_A=70\text{ }^\circ\text{C}$		± 27	
Pulsed Drain Current ^b		I_{DM}	± 50	
Continuous Source Current (Diode Conduction) ^a		I_S	2.3	A
Power Dissipation ^a	$T_A=25\text{ }^\circ\text{C}$	P_D	5.0	W
	$T_A=70\text{ }^\circ\text{C}$		3.2	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Maximum	Units
Maximum Junction-to-Ambient ^a	$t \leq 10\text{ sec}$	$R_{\theta JA}$	25	$^\circ\text{C/W}$
	Steady State		65	$^\circ\text{C/W}$

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ	Max	
Static						
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1		3	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA
		$V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			25	
On-State Drain Current ^A	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	34			A
Drain-Source On-Resistance ^A	$r_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$			3	m Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$			5	
Forward Transconductance ^A	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 7.5 \text{ A}$		22		S
Diode Forward Voltage	V_{SD}	$I_S = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		1.1		V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_D = 7.5 \text{ A}$		50		nC
Gate-Source Charge	Q_{gs}			20		
Gate-Drain Charge	Q_{gd}			20		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 25 \text{ V}, R_L = 25 \Omega, I_D = 34 \text{ A},$ $V_{GEN} = 10 \text{ V}$		40		nS
Rise Time	t_r			60		
Turn-Off Delay Time	$t_{d(off)}$			150		
Fall-Time	t_f			90		

Notes

- a. Pulse test: PW $\leq 300\mu\text{s}$ duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.